

# 产品规格承认书

## SPECIFICATIONS

客户:

CUSTOMER: \_\_\_\_\_

产品名称:

DESCRIPTION: \_\_\_\_\_ Monopole Antenna

客户型号:

CUSTOMER PART No: \_\_\_\_\_

产品型号:

OUR MODEL NO: \_\_\_\_\_ **PBX3216DD04**

日期:

DATE: \_\_\_\_\_


确认签字, 盖章后请返回承认书一份

PLEASERETRUV TO US ONE COPY OF “SPECIFICATION FOR APPROVAL”

WITY YOUR APPROVED SIGNATURES

Approved	LiuFei	Audit	LiuFei	Making	LiuXiaoMei
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Customer Acknowledges Signature	
Date	

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DESIGNED BY: Sera	APPROVED BY: XD		
TITLE: CHIP2450-3216 Specification		DOCUMENT NO.	SPEC REV.
		3216	P1

**PBX3216DD04 Specification**

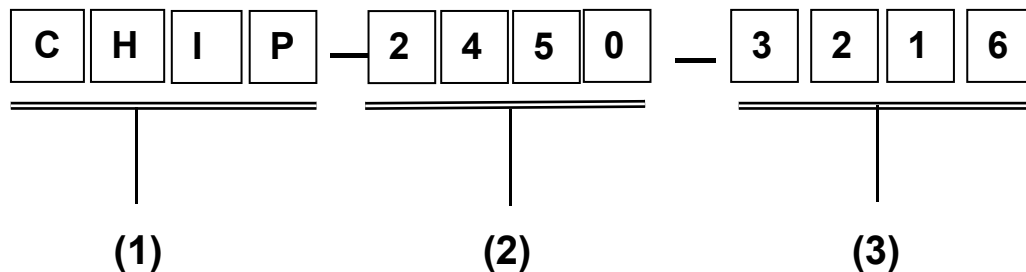
Operating Temp. : -40℃~+85℃

**1. FEATURES:**

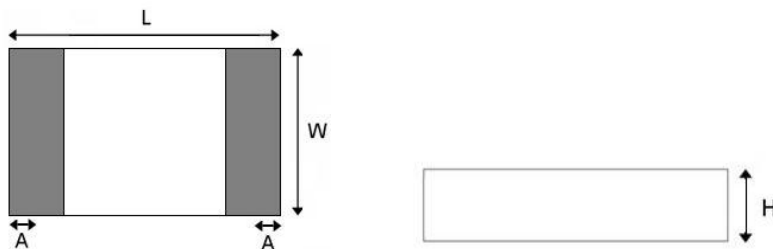
- Light weight, compact
- Wide bandwidth, low cost
- Built-in antenna with high gain

**2. APPLICATIONS:**

- Bluetooth, Wireless LAN, Mobile TV
- Home RF System, etc

**3. PRODUCT IDENTIFICATION**

- (1) Product type: Multilayer chip Antenna  
 (2) Center Frequency: 2450MHz  
 (3) External Dimensions (L×W) (mm): 3.2\*1.6

**4. SHAPE AND DIMENSIONS:**

L	W	H	A
3.2±0.2	1.6±0.2	1.0±0.1	0.4±0.1

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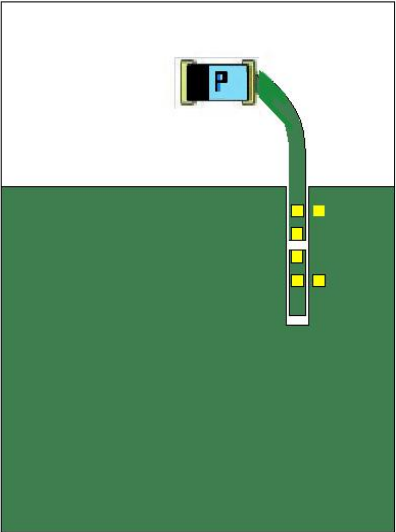
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Test plate reference size:

Company: mm



3216 Antenna



Top layer copper laying



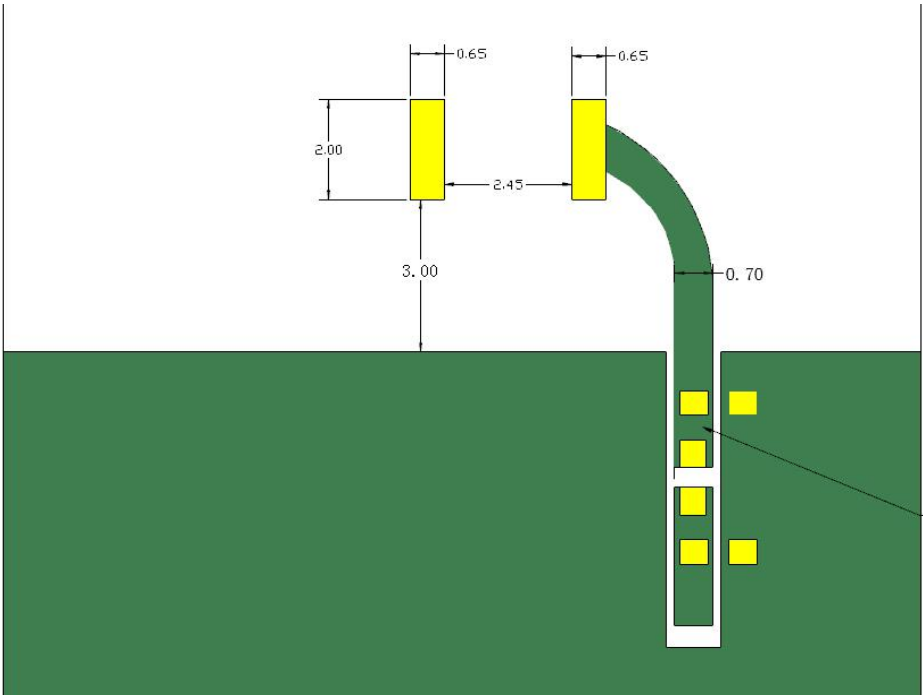
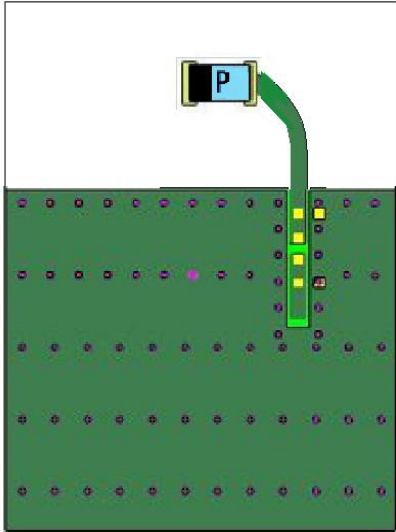
Pad



Copper laying  
on the bottom layer



Punch



50 Ω  
characteristic impedance

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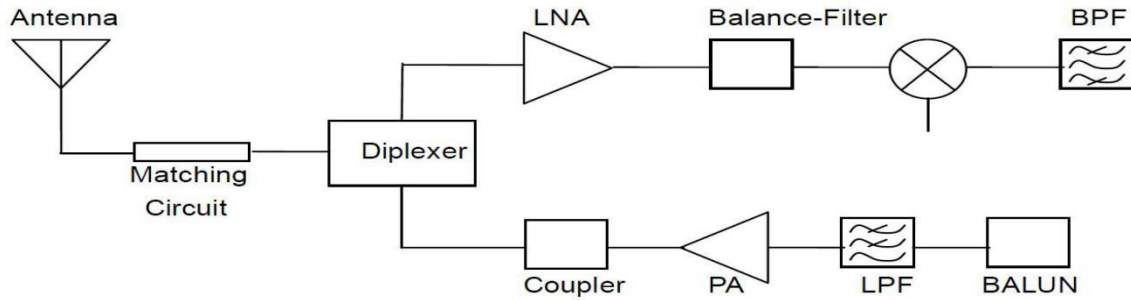
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**APPLICATION GUIDE****5. SPECIFICATIONS:**

No.	Product number	PBX3216DD04	
1	Central Frequency	2440	MHz
2	Bandwidth	100 (Min.)	MHz
3	Return Loss	-11.96 (Max.)	dB
4	Peak Gain	2.73	dBi
5	Impedance	50	$\Omega$
6	Operating Temperature	-40~+85	°C
7	Maximum Power	5	W
8	Resistance to soldering heat	10 (@260°C)	Sec.
9	Polarization	Linear	
10	Azimuth Beam width	Omni-directional	
11	Termination	Sn (leadless)	

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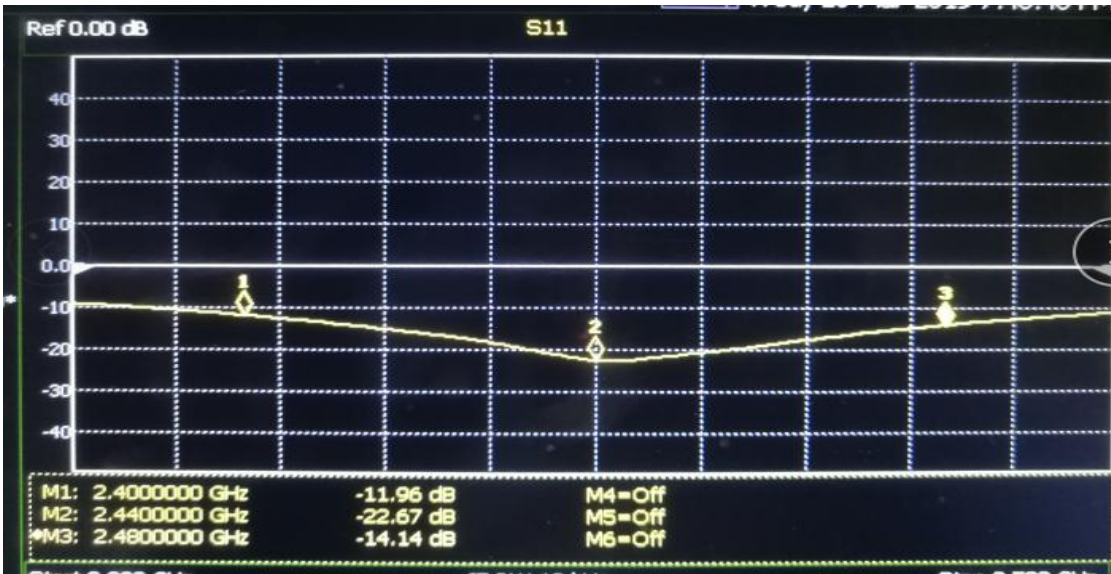
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6. Electrical Characteristics :



Frequency (MHz)	2400	2450	2500
Avg. Gain (dBi)	-1.83	-1.86	-2.97
Peck Gain (dBi)	2.73	2.58	1.34
Efficiency (%)	65.5	65.22	50.45

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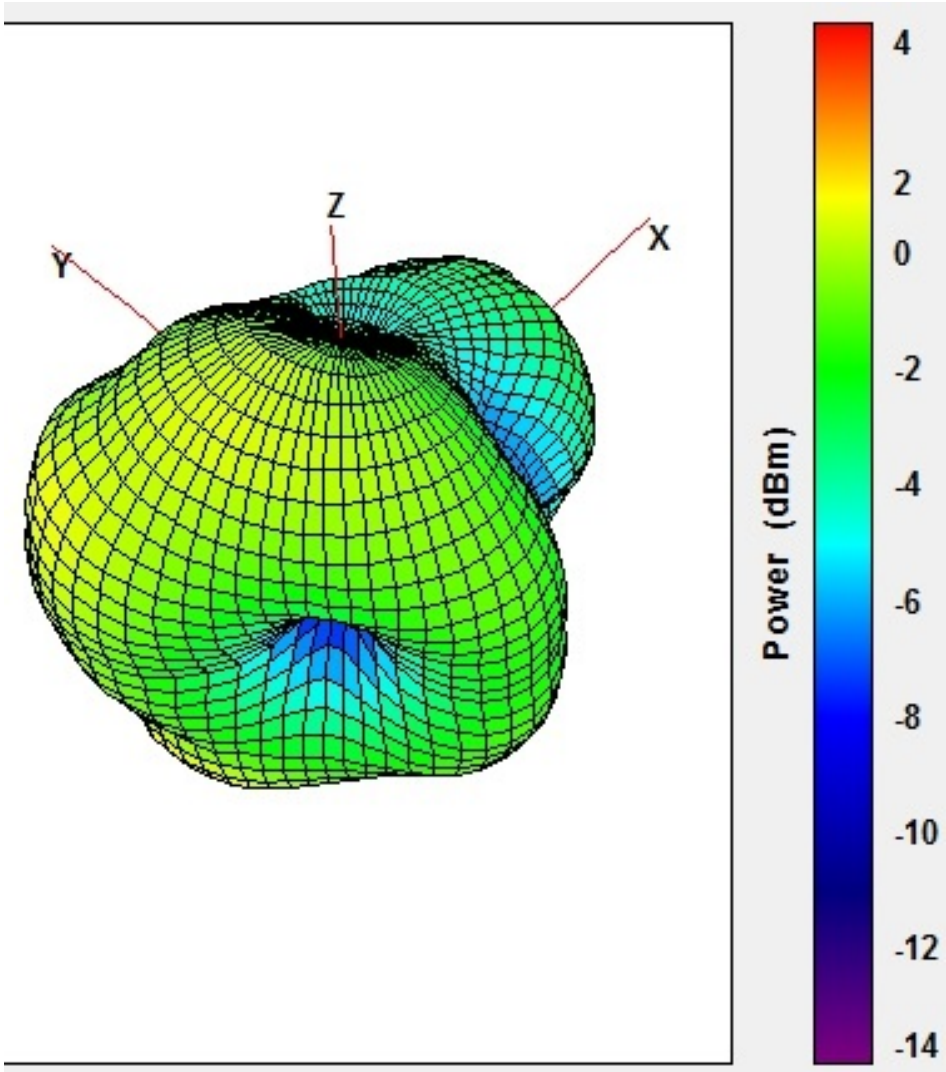
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3D Radiation Pattern



	Efficiency	Peak Gain	Directivity
2400MHz	55.21 %	2.73 dBi	5.32 dBi

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## 7. Environmental Characteristics

### (1) Reliability Test

Item	Condition	Specification
Thermal shock	1. $30\pm3$ minutes at $-40^{\circ}\text{C}\pm5^{\circ}\text{C}$ , 2. Convert to $+105^{\circ}\text{C}$ (5 minutes) 3. $30\pm3$ minutes at $+105^{\circ}\text{C}\pm5^{\circ}\text{C}$ , 4. Convert to $-40^{\circ}\text{C}$ (5 minutes) 5. Total 100 continuous cycles	No apparent damage Fulfill the electrical spec. after test.
Humidity resistance	1. Humidity: 85% R.H. 2. Temperature: $85\pm5^{\circ}\text{C}$ 3. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
High temperature resistance	1. Temperature: $150^{\circ}\text{C}\pm5^{\circ}\text{C}$ 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Low temperature resistance	1. Temperature: $-40^{\circ}\text{C}\pm5^{\circ}\text{C}$ 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Soldering heat resistance	1. Solder bath temperature : $260\pm5^{\circ}\text{C}$ 2. Bathing time: $10\pm1$ seconds	No apparent damage
Solderability	The dipped surface of the terminal shall be at least 95% covered with solder after dipped in solder bath of $245\pm5^{\circ}\text{C}$ for $3\pm1$ seconds.	No apparent damage

### (2) Storage Condition

#### (a) At warehouse:

The temperature should be within  $0\sim30^{\circ}\text{C}$  and humidity should be less than 60% RH.

The product should be used within 1 year from the time of delivery.

#### (b) On board:

The temperature should be within  $-40\sim85^{\circ}\text{C}$  and humidity should be less than 85% RH.

### (3) Operating Temperature Range

Operating temperature range :  $-40^{\circ}\text{C}$  to  $+105^{\circ}\text{C}$ .

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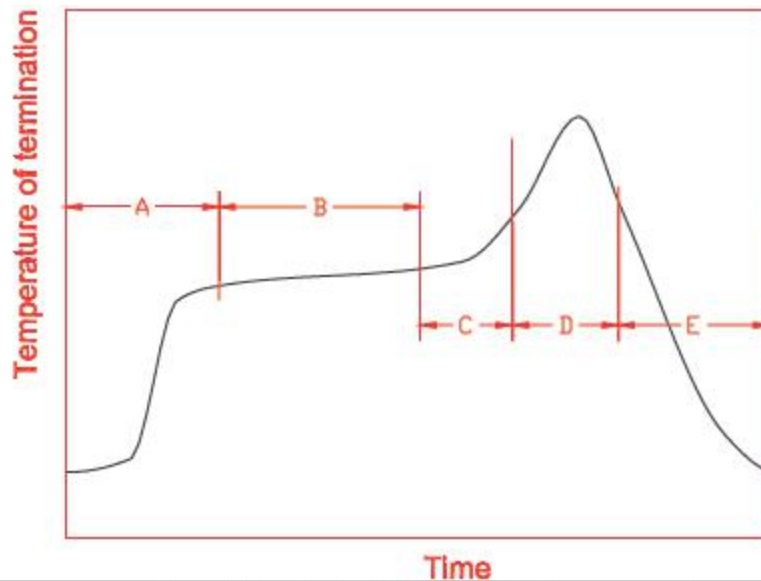
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## 8. Recommended Reflow Soldering



A	1 <sup>st</sup> rising temperature	The normal to Preheating temperature	30s to 60s
B	Preheating	140°C to 160°C	60s to 120s
C	2 <sup>nd</sup> rising temperature	Preheating to 200°C	20s to 40s
D	Main heating	if 220°C	50s~60s
		if 230°C	40s~50s
		if 240°C	30s~40s
		if 250°C	20s~40s
		if 260°C	20s~40s
E	Regular cooling	200°C to 100°C	1°C/s ~ 4°C/s

\*reference: J-STD-020C


### (1) Soldering Gun Procedure

Note the follows, in case of using solder gun for replacement.

- The tip temperature must be less than 350° C for the period within 3 seconds by using soldering gun under 30 W.
- The soldering gun tip shall not touch this product directly.

### (2) Soldering Volume

Note that excess of soldering volume will easily get crack the body of this product.

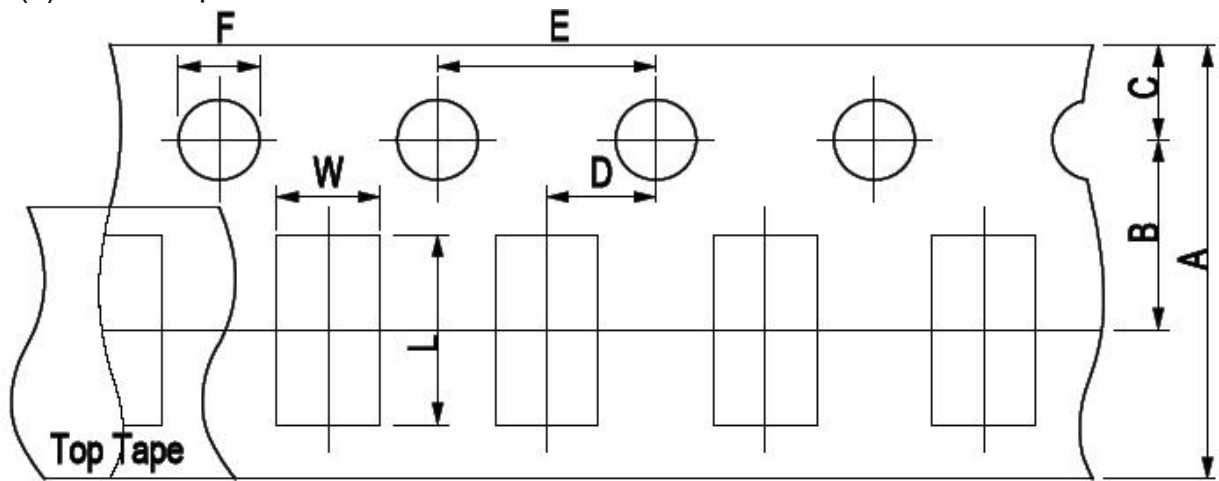
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**9. Taping Package and Label Marking:** (unit: mm)

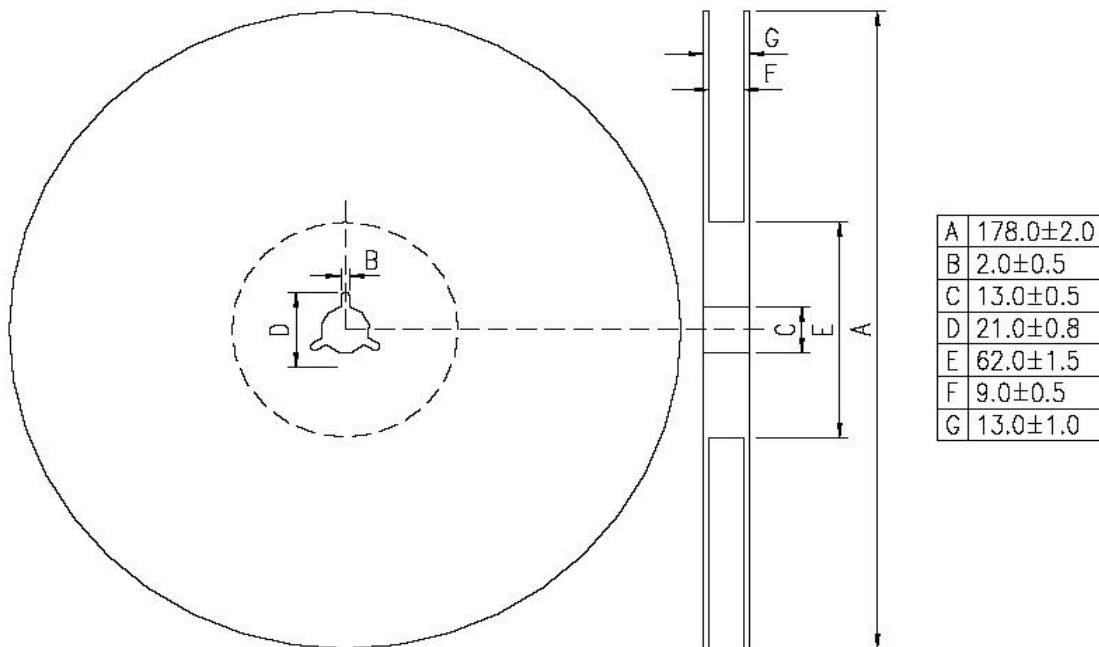
(1) Quantity/Reel: 5000pcs/Reel

(2) Carrier tape dimensions



Type	A	B	C	D	E	F	L	W
2450-21	$8.00 \pm 0.3$	$3.50 \pm 0.05$	$1.75 \pm 0.1$	$2.00 \pm 0.05$	$4.00 \pm 0.1$	$1.50 \pm 0.1$	$2.30 \pm 0.1$	$1.55 \pm 0.1$

(3) Taping reel dimensions



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